

# PRODUCT CHARACTERISTICS

|                                   |              |
|-----------------------------------|--------------|
| $V_{DSS}$                         | 650V         |
| $R_{DS(ON)}$ Typ(@ $V_{GS}=10V$ ) | 55m $\Omega$ |
| $Q_g$ @typ                        | 95.1nC       |
| $I_D$                             | 45A          |

# APPLICATIONS

- \* High efficiency switch mode power supplies
- \* Electronic lamp ballasts based on half bridge
- \* LED power supplies

# FEATURE

- \* High Switching Speed
- \* Improved dv/dt capability

# ORDER INFORMATION

| Order Codes  |              | Package | Packing        |
|--------------|--------------|---------|----------------|
| Halogen-Free | Halogen      |         |                |
| N/A          | MOT65R070GHF | TO-220F | 50 pieces/Tube |

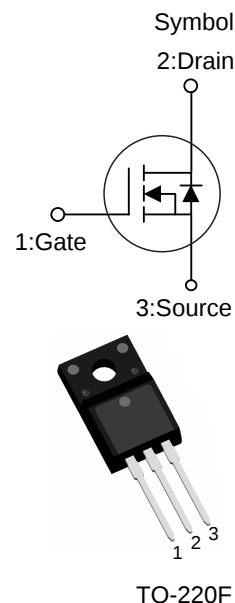
# ABSOLUTE MAXIMUM RATINGS( $T_A=25^{\circ}C$ , unless otherwise specified)

| Parameter                                                     | Symbol    | Ratings   | Unit        |
|---------------------------------------------------------------|-----------|-----------|-------------|
| Drain-Source Voltage                                          | $V_{DSS}$ | 650       | V           |
| Gate-Source Voltage                                           | $V_{GSS}$ | $\pm 30$  | V           |
| Drain Current Continuous(@ $V_{GS}=10V$ , $T_A=25^{\circ}C$ ) | $I_D$     | 45        | A           |
| Drain Current Pulsed                                          | $I_{DM}$  | 135       | A           |
| Avalanche Energy *                                            | $E_{AS}$  | 1800      | mJ          |
| Peak Diode Recovery dv/dt                                     | dv/dt     | 5.0       | V/ns        |
| Power Dissipation                                             | $P_D$     | 53        | W           |
| Junction Temperature                                          | $T_J$     | +150      | $^{\circ}C$ |
| Storage Temperature                                           | $T_{STG}$ | -55~ +150 | $^{\circ}C$ |

# THERMAL CHARACTERISTICS

| Parameter           | Symbol     | Typ  | Unit          |
|---------------------|------------|------|---------------|
| Junction to Ambient | $R_{thJA}$ | 62.5 | $^{\circ}C/W$ |
| Junction to Case    | $R_{thJC}$ | 2.35 | $^{\circ}C/W$ |

Note: \* EAS condition:  $T_J=25^{\circ}C$ ,  $V_{DD}=50V$ ,  $V_G=10V$ ,  $L=10mH$ ,  $R_g=25\Omega$



**■ ELECTRICAL CHARACTERISTICS** ( $T_C=25^{\circ}\text{C}$ , unless otherwise noted)

| Parameter                             | Symbol              | Test Conditions                                                                               | Min | Typ   | Max  | Unit |
|---------------------------------------|---------------------|-----------------------------------------------------------------------------------------------|-----|-------|------|------|
| Off characteristics                   |                     |                                                                                               |     |       |      |      |
| Drain to Source Breakdown Voltage     | V <sub>DSS</sub>    | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA                                                    | 650 | -     | -    | V    |
| Drain to Source Leakage Current       | I <sub>DSS</sub>    | V <sub>DS</sub> =650V, V <sub>GS</sub> =0V                                                    | -   | -     | 1    | μA   |
| Gate to Source Forward Leakage        | I <sub>GSS(F)</sub> | V <sub>DS</sub> =0V, V <sub>GS</sub> =+30V                                                    | -   | -     | 100  | nA   |
| Gate to Source Reverse Leakage        | I <sub>GSS(R)</sub> | V <sub>DS</sub> =0V, V <sub>GS</sub> =-30V                                                    | -   | -     | -100 | nA   |
| On characteristics                    |                     |                                                                                               |     |       |      |      |
| Drain to Source On-Resistance         | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =22A                                                     | -   | 57    | 70   | mΩ   |
| Gate Threshold Voltage                | V <sub>GS(TH)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                                      | 2   | -     | 4    | V    |
| Dynamic characteristics               |                     |                                                                                               |     |       |      |      |
| Gate capacitance                      | R <sub>g</sub>      | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V ,f=1.0MHz                                            | -   | 0.7   | -    | Ω    |
| Forward Transconductance              | g <sub>fs</sub>     | V <sub>DS</sub> =10V, I <sub>D</sub> =5A                                                      | -   | 16    | -    | S    |
| Input Capacitance                     | C <sub>iss</sub>    | V <sub>DS</sub> =40V, V <sub>GS</sub> =0V<br>f=1.0MHz                                         | -   | 4100  | -    | pF   |
| Output Capacitance                    | C <sub>oss</sub>    |                                                                                               | -   | 381   | -    | pF   |
| Reverse Transfer Capacitance          | C <sub>rss</sub>    |                                                                                               | -   | 3.3   | -    | pF   |
| Resistive Switching Characteristics   |                     |                                                                                               |     |       |      |      |
| Turn-on Delay Time                    | t <sub>d(ON)</sub>  | I <sub>D</sub> =22 A, V <sub>DS</sub> =400V<br><br>R <sub>G</sub> =10Ω , V <sub>GS</sub> =10V | -   | 158.9 | -    | ns   |
| Rise Time                             | t <sub>r</sub>      |                                                                                               | -   | 23    | -    | ns   |
| Turn-off Delay Time                   | t <sub>d(OFF)</sub> |                                                                                               | -   | 109.5 | -    | ns   |
| Fall Time                             | t <sub>f</sub>      |                                                                                               | -   | 6.2   | -    | ns   |
| Total Gate Charge                     | Q <sub>g</sub>      | I <sub>D</sub> =22A, V <sub>DS</sub> =520V<br>V <sub>GS</sub> =10V                            | -   | 95.1  | -    | nC   |
| Gate to Source Charge                 | Q <sub>gs</sub>     |                                                                                               | -   | 27.4  | -    | nC   |
| Gate to Drain("Miller") Charge        | Q <sub>gd</sub>     |                                                                                               | -   | 35.1  | -    | nC   |
| Source-Drain Diode Characteristics    |                     |                                                                                               |     |       |      |      |
| Continuous Source Current(Body Diode) | I <sub>s</sub>      |                                                                                               | -   | -     | 45   | A    |
| Maximum Pulsed Current(Body Diode)    | I <sub>SM</sub>     |                                                                                               | -   | -     | 135  | A    |
| Diode Forward Voltage                 | V <sub>SD</sub>     | I <sub>SD</sub> =1A, V <sub>GS</sub> =0V                                                      | -   | 0.74  | 1.2  | V    |
| Reverse Recovery Time                 | t <sub>rr</sub>     | I <sub>SD</sub> =22 A, T <sub>J</sub> =25 °C                                                  | -   | 180   | -    | ns   |
| Reverse Recovery Charge               | Q <sub>rr</sub>     | dI /dt=100A/μs                                                                                | -   | 1500  | -    | nC   |

## ■ TYPICAL CHARACTERISTICS

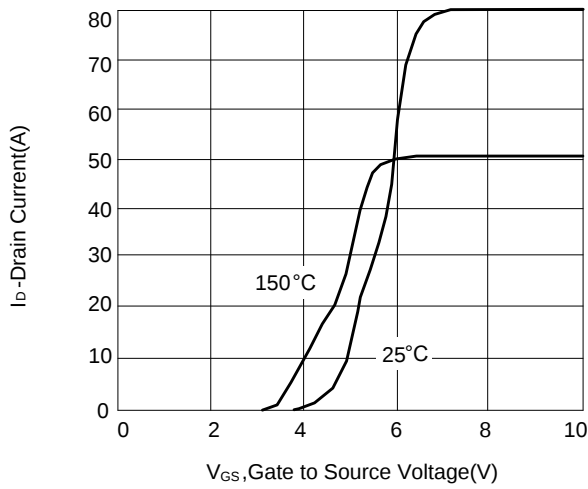


Figure 1: Transfer Characteristics

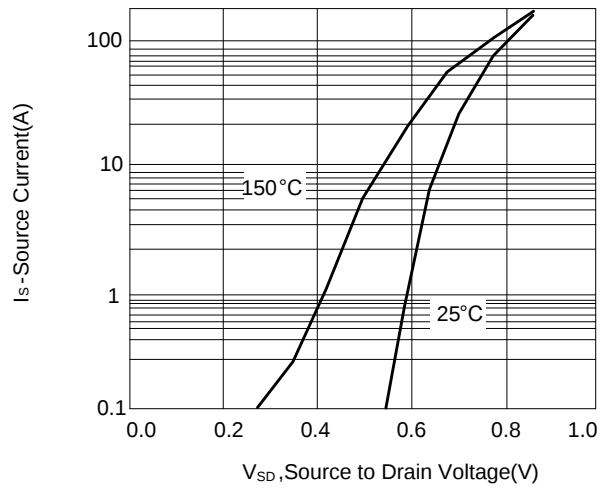


Figure 2: Body Diode Characteristics

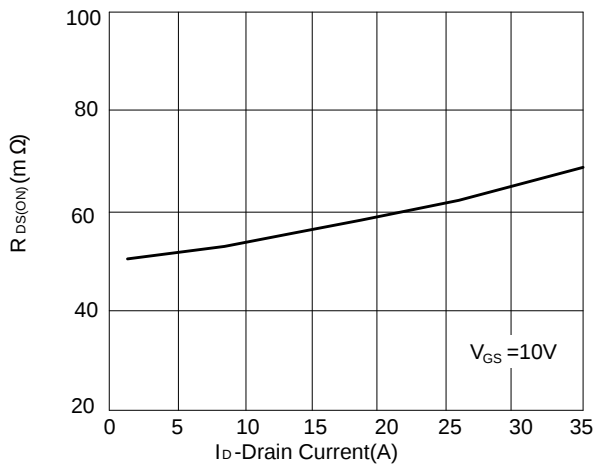


Figure 3: Drain to Source On-Resistance vs Drain Current

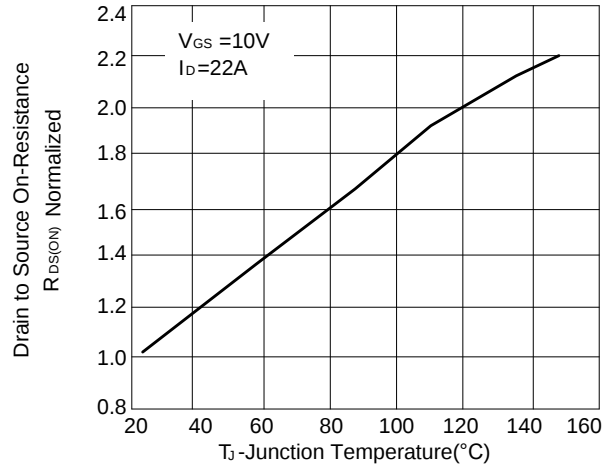


Figure 4: Drain to Source On-Resistance vs Junction Temperature

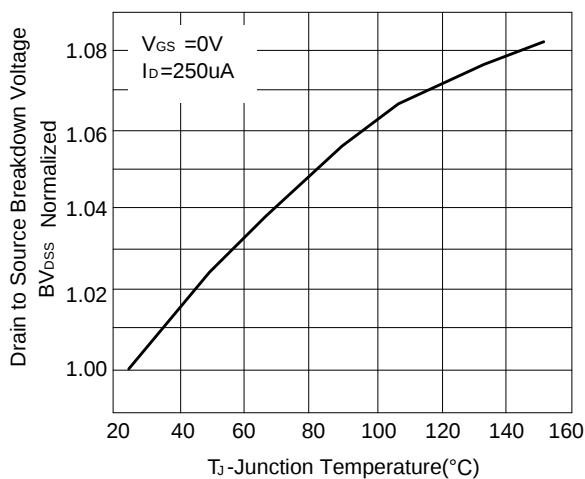


Figure 5: Breakdown Voltage vs Junction Temperature

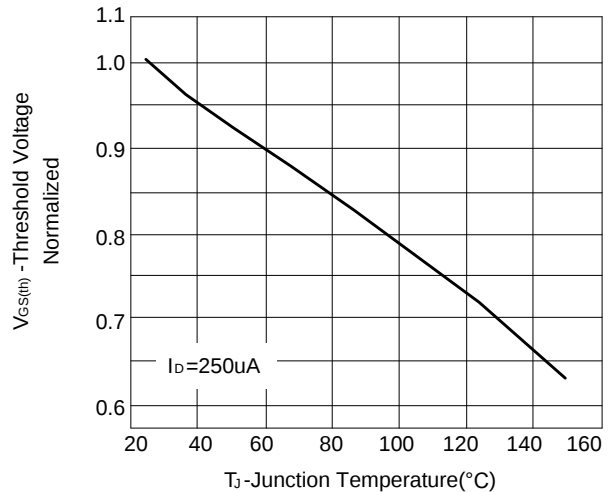


Figure 6: Threshold Voltage vs Junction Temperature

■ TYPICAL CHARACTERISTICS(Cont.)

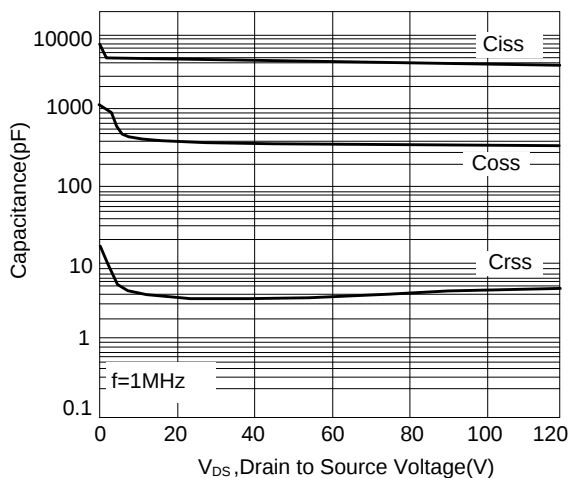


Figure 7: Capacitance vs Drain to Source Voltage

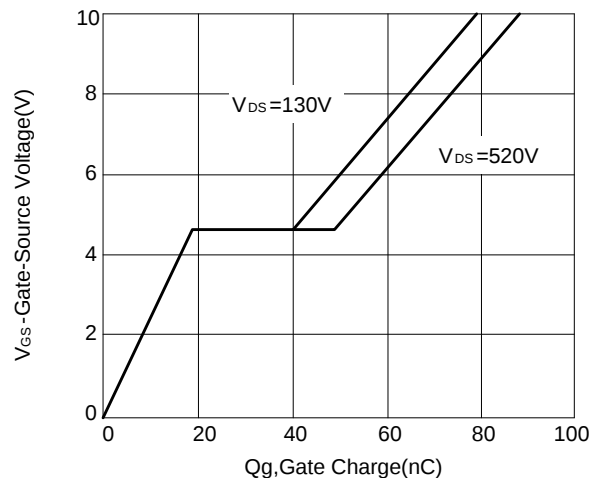


Figure 8: Gate Charge vs Gate to Source Voltage

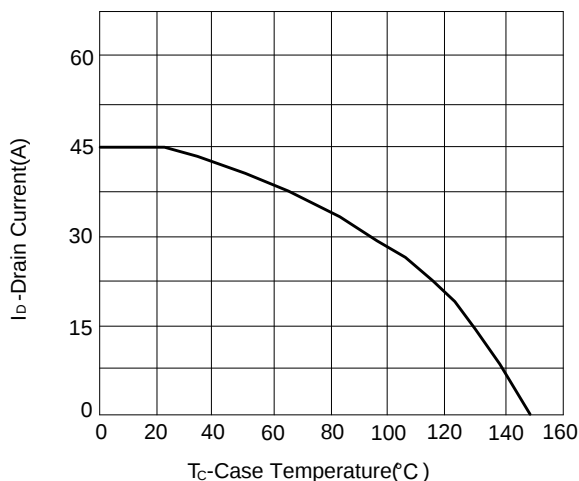


Figure 9: Continuous Drain vs Case Temperature

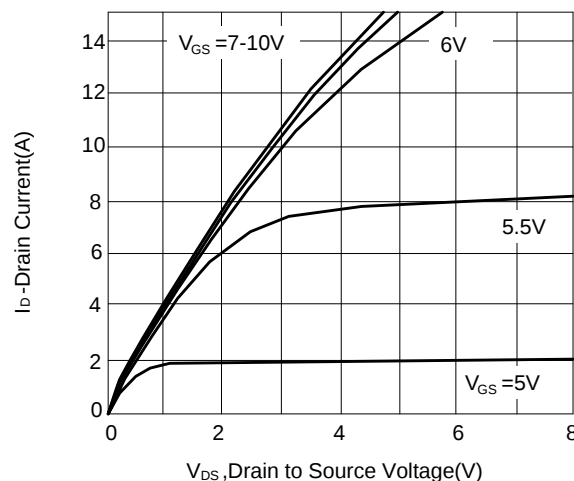


Figure 10: Output Characteristics

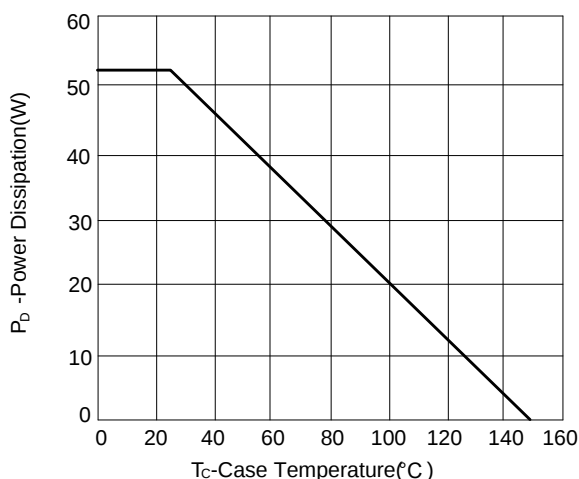


Figure 11: Power Dissipation vs Case Temperature

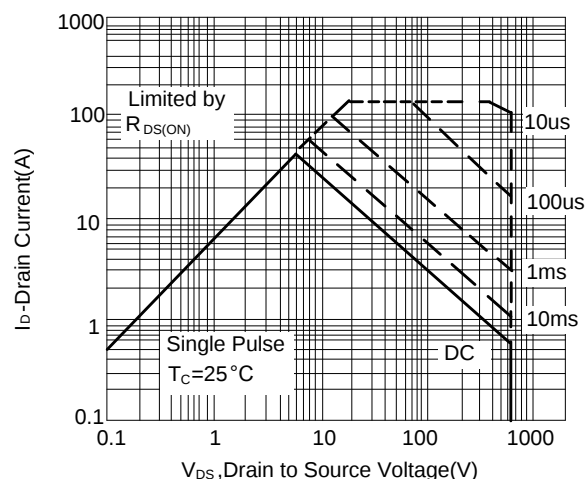


Figure 12: Safe operating Area

## ■ TO-220F PACKAGE OUTLINE DIMENSIONS

